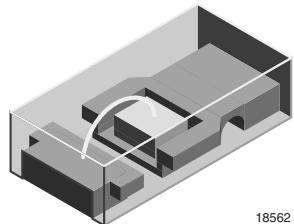


## Standard 0603 SMD LED



18562

### DESCRIPTION

The new 0603 LED series has been designed in the smallest SMD package. This innovative 0603 LED technology opens the way to

- smaller products of higher performance
- more design in flexibility
- enhanced applications

The 0603 LED is an obvious solution for small-scale, high power products that are expected to work reliable in an arduous environment.

### PRODUCT GROUP AND PACKAGE DATA

- Product group: LED
- Package: SMD 0603
- Product series: standard
- Angle of half intensity:  $\pm 80^\circ$

### FEATURES

- Smallest SMD package 0603 with exceptional brightness 1.6 mm x 0.8 mm x 0.6 mm (L x W x H)
- High reliability lead frame based
- Temperature range - 40 °C to + 100 °C
- Footprint compatible to 0603 chipled
- Wavelength 633 nm (super red)
- Viewing angle: extremely wide 160°
- Grouping parameter: luminous intensity, wavelength
- Available in 8 mm tape
- Compatible to IR reflow soldering
- Compliant to RoHS directive 2002/95/EC and in accordance to WEEE 2002/96/EC
- Qualified according to JEDEC moisture sensitivity level 2
- ESD-withstand voltage: up to 2 kV according to JESD22-A114-B
- AEC-Q101 qualified



e4

**RoHS**  
COMPLIANT

### APPLICATIONS

- Backlight keypads
- Navigation systems
- Cellular phone displays
- Displays for industrial control systems
- Automotive features
- Miniaturized color effects
- Traffic displays

### PARTS TABLE

PART	COLOR, LUMINOUS INTENSITY	TECHNOLOGY
VLMS11P2Q2-GS08	Super red, $I_V = (56 \text{ to } 112) \text{ mcd}$	AlInGaP

**ABSOLUTE MAXIMUM RATINGS <sup>1)</sup> VLMS11P2Q2**

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Reverse voltage <sup>2)</sup>		$V_R$	12	V
DC Forward current	$T_{amb} \leq 75 \text{ }^{\circ}\text{C}$	$I_F$	30	mA
Surge forward current	$t_p \leq 10 \mu\text{s}$	$I_{FSM}$	0.5	A
Power dissipation		$P_V$	90	mW
Junction temperature		$T_j$	120	$^{\circ}\text{C}$
Operating temperature range		$T_{amb}$	- 40 to + 100	$^{\circ}\text{C}$
Storage temperature range		$T_{stg}$	- 40 to + 100	$^{\circ}\text{C}$
Soldering temperature	Acc. Vishay spec	$T_{sd}$	260	$^{\circ}\text{C}$
Thermal resistance junction/ambient	Mounted on PC board (pad size > 5 mm <sup>2</sup> )	$R_{thJA}$	480	K/W

Note:

1)  $T_{amb} = 25 \text{ }^{\circ}\text{C}$ , unless otherwise specified

2) Driving the LED in reverse direction is suitable for short term application

**OPTICAL AND ELECTRICAL CHARACTERISTICS VLMS11P2Q2, SUPER RED**

PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Luminous intensity	$I_F = 20 \text{ mA}$	$I_V$	56		112	mcd
Dominant wavelength	$I_F = 20 \text{ mA}$	$\lambda_d$	627	633	639	nm
Peak wavelength	$I_F = 20 \text{ mA}$	$\lambda_p$		641		nm
Angle of half intensity	$I_F = 20 \text{ mA}$	$\varphi$		$\pm 80$		deg
Forward voltage	$I_F = 20 \text{ mA}$	$V_F$		2.1	3	V
Reverse voltage	$I_R = 10 \mu\text{A}$	$V_R$	6			V
Junction capacitance	$V_R = 0, f = 1 \text{ MHz}$	$C_j$		15		pF

Note:

 $T_{amb} = 25 \text{ }^{\circ}\text{C}$ , unless otherwise specifiedWavelengths are tested at a current pulse duration of 25 ms and an accuracy of  $\pm 1 \text{ nm}$ 
**LUMINOUS INTENSITY CLASSIFICATION**

GROUP	LUMINOUS INTENSITY (mcd)	
	MIN.	MAX.
P2	56	71
Q1	71	90
Q2	90	112

Note:

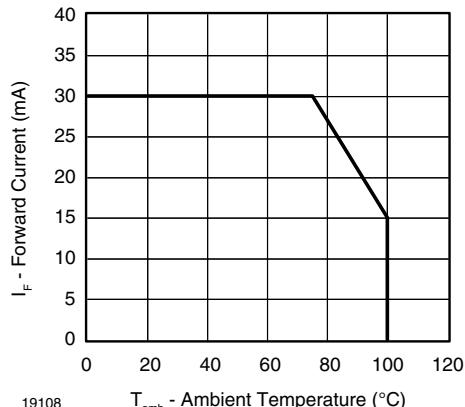
Luminous intensity is tested at a current pulse duration of 25 ms and an accuracy of  $\pm 11 \text{ %}$ .

The above type numbers represent the order groups which include only a few brightness groups. Only one group will be shipped on each reel (there will be no mixing of two groups on each reel).

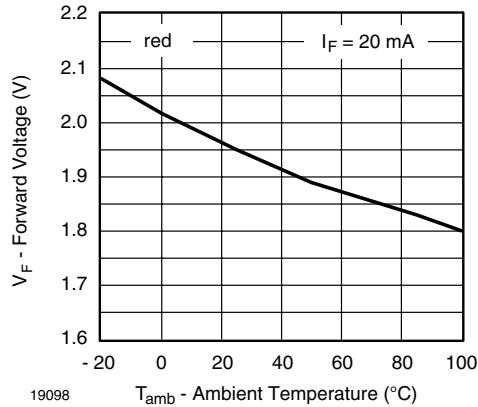
In order to ensure availability, single brightness groups will not be orderable.

In a similar manner for colors where wavelength groups are measured and binned, single wavelength groups will be shipped in any one reel.

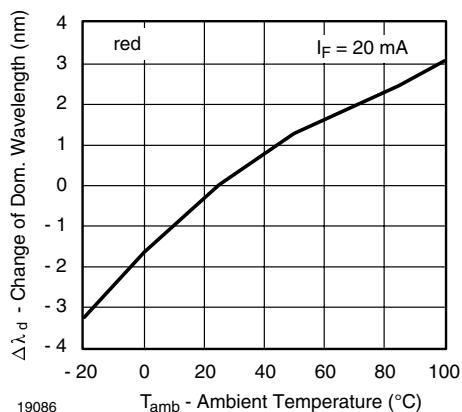
In order to ensure availability, single wavelength groups will not be orderable.

**TYPICAL CHARACTERISTICS**
 $T_{amb} = 25 \text{ }^{\circ}\text{C}$ , unless otherwise specified


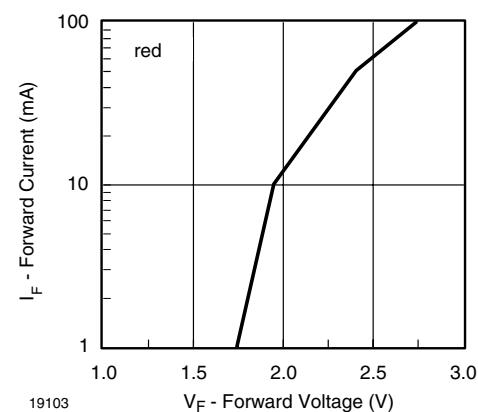
19108



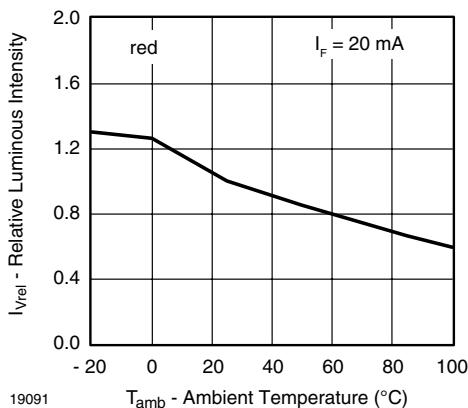
19098



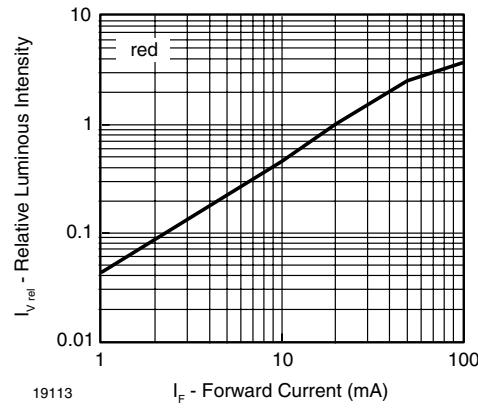
19086



19103

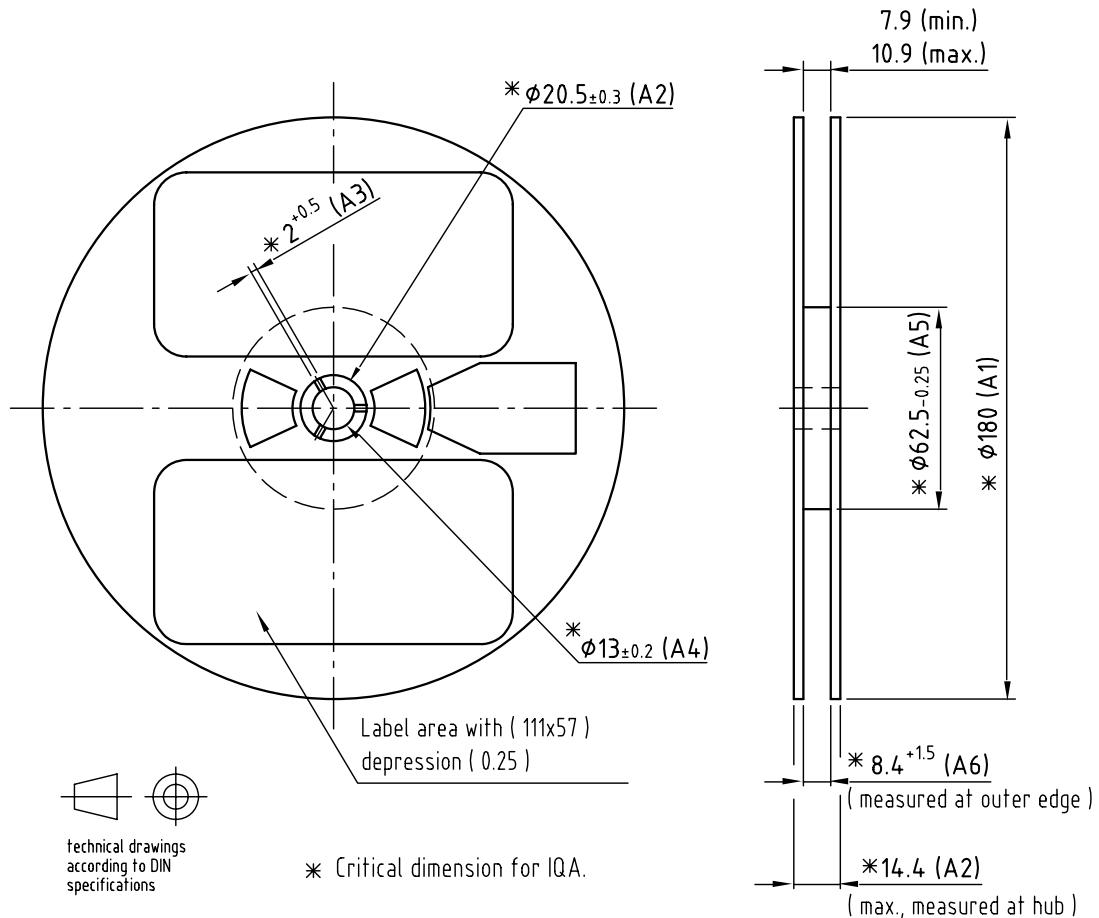


19091



19113

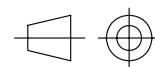
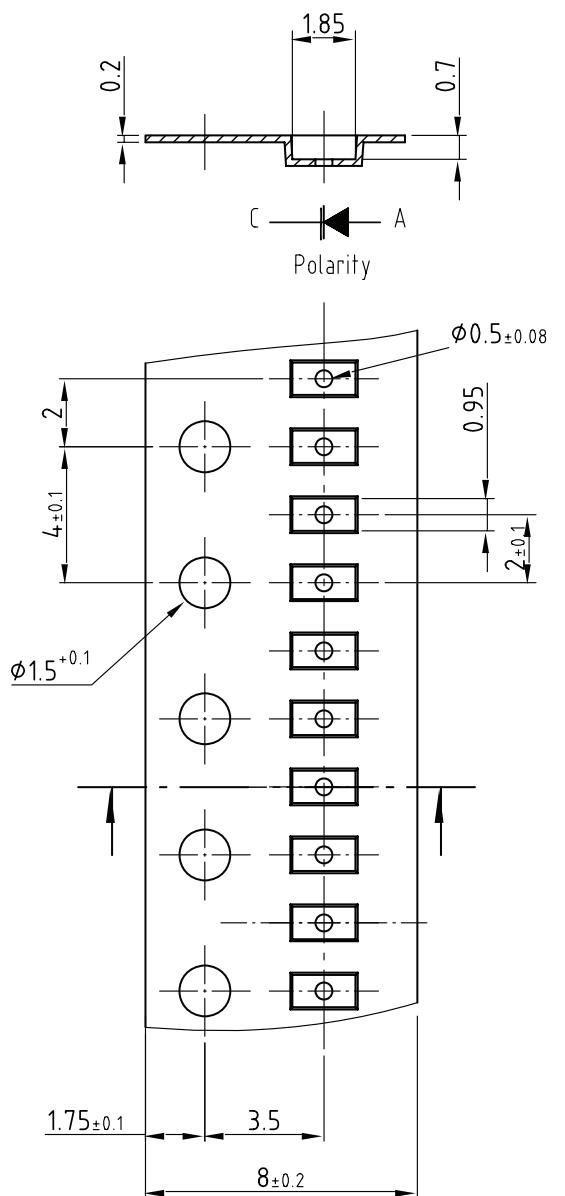
## REEL DIMENSIONS in millimeters



Drawing-No.: 9.800-5086.01-4

Issue: 1; 29.04.04

19043

**TAPE DIMENSIONS** in millimeters


Technical drawings  
according to DIN  
specifications

Not indicated tolerances ±0.05

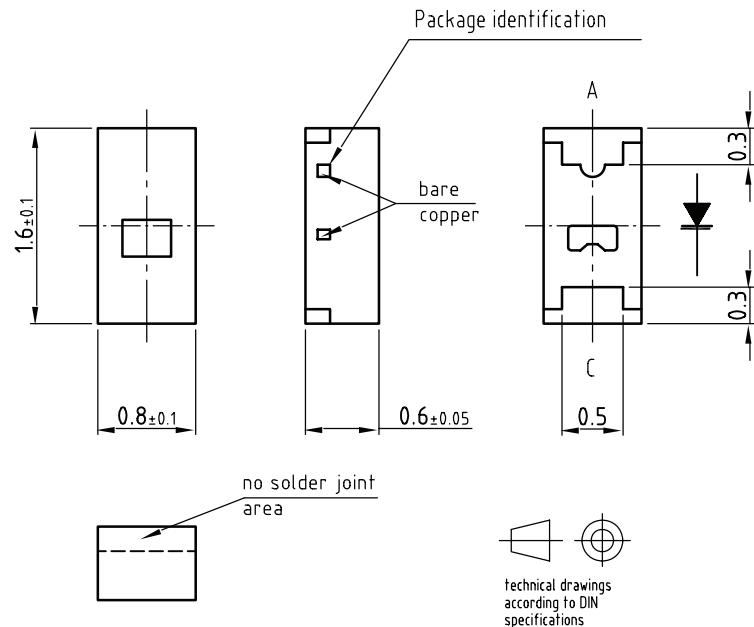
Material: Conductive black PC

Drawing-No.: 9.700-5290.01-4

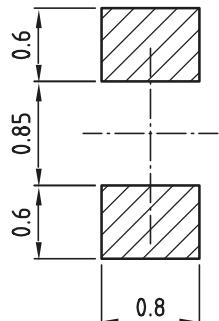
Issue: 2; 10.07.06

19044

## PACKAGE DIMENSIONS in millimeters

Not indicated tolerances  $\pm 0.1$ 

Recommended solder pad



Drawing-No.: 6.541-5056.01-4

Issue: 2; 04.05.05

19426

## SOLDERING PROFILE

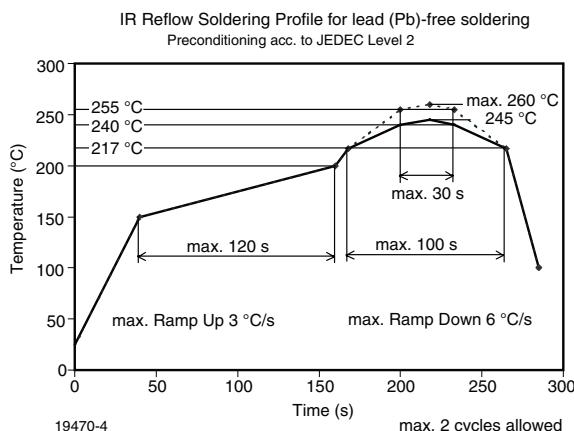
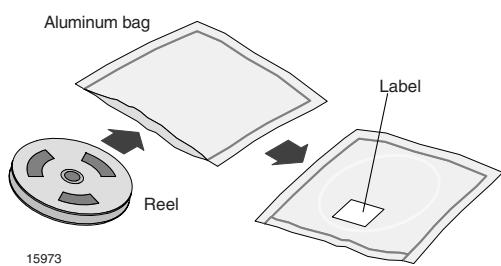


Figure 7. Vishay Lead (Pb)-free Reflow Soldering Profile  
(acc. to J-STD-020C)

## DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



## FINAL PACKING

The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.

## RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 1 year under these conditions moisture content will be too high for reflow soldering.

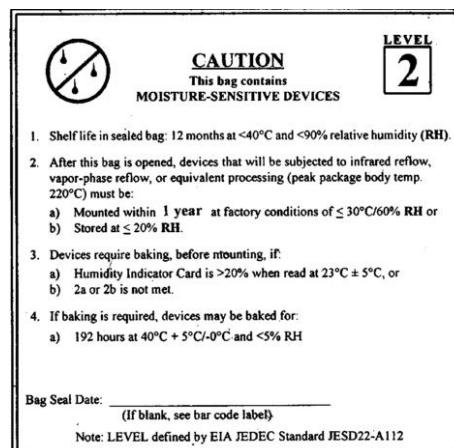
In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 h at 40 °C + 5 °C/- 0 °C and < 5 % RH (dry air/nitrogen) or

96 h at 60 °C + 5 °C and < 5 % RH for all device containers or

24 h at 100 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC standard JESD22-A112 level 2 label is included on all dry bags.



Example of JESD22-A112 level 2 label

## ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electro-static sensitive devices warning labels are on the packaging.

## VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.

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